

Film Capacitors

Metallized Polypropylene Film Capacitors (MKP)

Series/Type:B32671P ... B32673PDate:November 2019

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Metallized polypropylene film capacitors (MKP)

Power Factor Correction

B32671P ... B32673P

Typical applications

PFC (Power Factor Correction)

Climatic

- Max. operating temperature: 125 °C
- Climatic category (IEC 60068-1:2013): 55/110/56

Construction

- Dielectric: polypropylene (PP)
- Wound capacitor technology
- Plastic case (UL 94 V-0)
- Epoxy resin sealing

Features

- Very compact design
- Very small dimensions
- Very high ripple and peak current
- High frequency AC operation capability
- High voltage capability
- Excellent self-healing property
- RoHS-compatible
- Halogen-free capacitors available on request
- AEC-Q200D compliant

Terminals

- Parallel wire leads, lead free, tinned
- Special lead lengths available on request

Marking

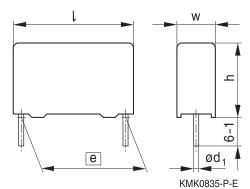
- Manufacturer's logo
- Lot number, series number
- Rated capacitance (coded)
- Capacitance tolerance (code letter)
- Rated DC voltage
- Date of manufacture (coded)

Delivery mode

- Bulk (untaped)
- Taped (Ammo pack or reel)

For notes on taping, refer to chapter "Taping and packing".

Dimensional drawing



Dimensions in mm

Lead spacing	Lead diameter	Туре
<i>e</i> ±0.4	d ₁ ±0.05	
10	0.6	B32671P
15	0.8	B32672P
22.5	0.8	B32673P



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Power Factor Correction

Overview of available types

Lead spacing 10 mm			15 mm		22.5 mm				
Туре	B32671P		B32672P		B32673P				
Page	4			5			6		
V _{RMS} (V AC)	160	200	200	160	200	200	160	200	200
V _R (V DC)	450	520	630	450	520	630	450	520	630
C _R (μF)									
0.068									
0.082									
0.10									
0.15									
0.18									
0.22									
0.27									
0.33									
0.39									
0.47									
0.56									
0.68									
1.0									
1.5									
2.0									
2.2									





B32671P

Power Factor Correction

Ordering codes and packing units (lead spacing 10 mm)

V _R	V _{RMS}	C _R	Ordering code	Max. dimensions	Ammo	Reel	Untaped
	f ≤1 kHz		(composition see	$w \times h \times l$	pack		
V DC	V AC	μF	below)	mm	pcs./MOQ	pcs./MOQ	pcs./MOQ
450	160	0.10	B32671P4104+***	$4.0\times 9.0\times 13.0$	4000	6800	4000
		0.15	B32671P4154+***	$4.0\times 9.0\times 13.0$	4000	6800	4000
		0.18	B32671P4184+***	5.0 imes 11.0 imes 13.0	3320	5200	4000
		0.22	B32671P4224+***	5.0 imes 11.0 imes 13.0	3320	5200	4000
		0.27	B32671P4274+***	5.0 imes 11.0 imes 13.0	3320	5200	4000
		0.33	B32671P4334+***	$6.0\times12.0\times13.0$	2720	4400	4000
		0.39	B32671P4394+***	$6.0\times12.0\times13.0$	2720	4400	4000
		0.47	B32671P4474+***	$6.0\times14.0\times13.0$	2720	4400	4000
		0.68	B32671P4684+***	$7.0\times16.0\times13.0$	_	_	4000
		1.0	B32671P4105+***	$8.0\times17.5\times13.0$	_	—	2000
520	200	0.082	B32671P5823+***	$4.0\times 9.0\times 13.0$	4000	6800	4000
		0.10	B32671P5104+***	5.0 imes 11.0 imes 13.0	3320	5200	4000
		0.15	B32671P5154+***	5.0 imes 11.0 imes 13.0	3320	5200	4000
		0.22	B32671P5224+***	$6.0\times12.0\times13.0$	2720	4400	4000
		0.33	B32671P5334+***	$7.0\times16.0\times13.0$	_	_	4000
		0.47	B32671P5474+***	$8.0\times17.5\times13.0$	_	_	2000
630	200	0.068	B32671P6683+***	$4.0\times 9.0\times 13.0$	4000	6800	4000
		0.082	B32671P6823+***	5.0 imes 11.0 imes 13.0	3320	5200	4000
		0.10	B32671P6104+***	5.0 imes 11.0 imes 13.0	3320	5200	4000
		0.15	B32671P6154+***	$6.0\times12.0\times13.0$	2720	4400	4000
		0.18	B32671P6184+***	$6.0\times12.0\times13.0$	2720	4400	4000
		0.22	B32671P6224+***	$6.0\times14.0\times13.0$	2720	4400	4000
		0.33	B32671P6334+***	$8.0\times17.5\times13.0$	_	_	2000
		0.39	B32671P6394+***	$8.0\times17.5\times13.0$	_	—	2000

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series, intermediate capacitance values and closer tolerance on request.

Composition of ordering code

- + = Capacitance tolerance code:
 - $J = \pm 5\%$
 - $K = \pm 10\%$
 - $M = \pm 20\%$

*** = Packaging code:

- 289 = Straight terminals, Ammo pack
- 189 = Straight terminals, Reel
- 003 = Straight terminals, untaped (lead length $3.2 \pm 0.3 \text{ mm}$)
- 000 = Straight terminals, untaped (lead length 6-1 mm)



B32672P Power Factor Correction



Ordering codes and packing units (lead spacing 15 mm)

V _R	V _{RMS}	C _R	Ordering code	Max. dimensions	Ammo	Reel	Untaped
	f≤1 kHz		(composition see	$w \times h \times l$	pack		
V DC	V AC	μF	below)	mm	pcs./MOQ	pcs./MOQ	pcs./MOQ
450	160	0.10	B32672P4104+***	5.0 imes 10.5 imes 18.0	4680	5200	4000
		0.22	B32672P4224+***	5.0 imes 10.5 imes 18.0	4680	5200	4000
		0.33	B32672P4334+***	5.0 imes 10.5 imes 18.0	4680	5200	4000
		0.47	B32672P4474+***	5.0 imes 10.5 imes 18.0	4680	5200	4000
		0.56	B32672P4564+***	$6.0\times11.0\times18.0$	3840	4400	4000
		0.68	B32672P4684+***	$6.0 \times 12.0 \times 18.0$	3840	4400	4000
		1.0	B32672P4105+***	$7.0\times12.5\times18.0$	3320	3600	4000
		1.5	B32672P4155+***	9.0 imes17.5 imes18.0	2560	2800	2000
		2.0	B32672P4205+***	9.0 imes17.5 imes18.0	2560	2800	2000
		2.2	B32672P4225+***	11.0 imes 18.5 imes 18.0	_	2200	1200
520	200	0.15	B32672P5154+***	$5.0\times10.5\times18.0$	4680	5200	4000
		0.22	B32672P5224+***	$5.0\times10.5\times18.0$	4680	5200	4000
		0.33	B32672P5334+***	$6.0\times11.0\times18.0$	3840	4400	4000
		0.47	B32672P5474+***	$7.0\times12.5\times18.0$	3320	3600	4000
		0.68	B32672P5684+***	$8.5 \times 14.5 \times 18.0$	2720	2800	2000
		1.0	B32672P5105+***	9.0 imes 17.5 imes 18.0	2560	2800	2000
		1.5	B32672P5155+***	$11.0\times18.5\times18.0$	_	2200	1200
630	200	0.15	B32672P6154+***	$5.0\times10.5\times18.0$	4680	5200	4000
		0.22	B32672P6224+***	$6.0\times11.0\times18.0$	3840	4400	4000
		0.33	B32672P6334+***	$7.0\times12.5\times18.0$	3320	3600	4000
		0.47	B32672P6474+***	$8.0\times14.0\times18.0$	2920	3000	2000
		0.68	B32672P6684+***	$9.0\times17.5\times18.0$	2560	2800	2000
		1.0	B32672P6105+***	$11.0\times18.5\times18.0$	_	2200	1200

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Further E series, intermediate capacitance values and closer tolerance on request.

Composition of ordering code

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 - $K = \pm 10\%$
 - $M = \pm 20\%$

*** = Packaging code:

- 289 = Straight terminals, Ammo pack
- 189 = Straight terminals, Reel
- 003 = Straight terminals, untaped (lead length $3.2 \pm 0.3 \text{ mm}$)
- 000 = Straight terminals, untaped (lead length 6-1 mm)





B32673P

Power Factor Correction

Ordering codes and packing units (lead spacing 22.5 mm)

V _R	V _{RMS}	C _R	Ordering code	Max. dimensions	Ammo	Reel	Untaped
	f ≤1 kHz		(composition see	$w \times h \times I$	pack		
V DC	V AC	μF	below)	mm	pcs./MOQ	pcs./MOQ	pcs./MOQ
450	160	1.0	B32673P4105+***	$6.0 \times 15.0 \times 26.5$	2720	2800	2880
		1.5	B32673P4155+***	$7.0\times16.0\times26.5$	2320	2400	2520
		2.2	B32673P4225+***	$8.5 \times 16.5 \times 26.5$	1920	2000	2040
520	200	0.47	B32673P5474+***	$6.0\times15.0\times26.5$	2720	2800	2880
		0.56	B32673P5564+***	$6.0\times15.0\times26.5$	2720	2800	2880
		0.68	B32673P5684+***	$6.0\times15.0\times26.5$	2720	2800	2880
		1.0	B32673P5105+***	$7.0\times16.0\times26.5$	2320	2400	2520
		1.5	B32673P5155+***	$10.5\times16.5\times26.5$	1560	1600	2160
		2.2	B32673P5225+***	$10.5\times20.5\times26.5$	_	_	2160
630	200	0.33	B32673P6334+***	$6.0 \times 15.0 \times 26.5$	2720	2800	2880
		0.47	B32673P6474+***	$6.0\times15.0\times26.5$	2720	2800	2880
		0.56	B32673P6564+***	$6.0\times15.0\times26.5$	2720	2800	2880
		0.68	B32673P6684+***	$7.0\times16.0\times26.5$	2320	2400	2520
		1.0	B32673P6105+***	$8.5\times16.5\times26.5$	1920	2000	2040
		1.5	B32673P6155+***	$10.5\times18.5\times26.5$	1560	1600	2160
		2.2	B32673P6225+***	$12.0\times22.0\times26.5$	_	_	1800

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series, intermediate capacitance values and closer tolerance on request.

Composition of ordering code

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 - $K = \pm 10\%$
 - $M = \pm 20\%$

- *** = Packaging code:
 - 289 = Straight terminals, Ammo pack
 - 189 = Straight terminals, Reel
 - 003 = Untaped (lead length 3.2 \pm 0.3 mm)
 - 000 = Untaped (lead length 6-1 mm)



MKP

Power Factor Correction

Technical data

Reference standard: IEC 60384-16:2005 and AEC-Q200D. All data given at T = 20 $^{\circ}$ C, unless otherwise specified.

Rated temperature T _R	+85 °C		
Operating temperature	Max. operating	temperature T _{op, max}	+125 °C
range	Upper category	y temperature T _{max}	+110 °C
	Lower category	y temperature T _{min}	−55 °C
	Rated tempera	ture T _R	+85 °C
Dissipation factor tan δ	at 1 kHz:	1.0	
(in 10⁻³) at 20 °C	at 10 kHz:	2.5	
(upper limit values)	at 100 kHz: 2	25.0	
Insulation resistance R _{ins}	$30 \text{ G}\Omega \text{ (C}_{\text{R}} \leq 0.1$.33 μF)	
at 100 V or time constant	10000 s (C _R >	0.33 μF)	
$\tau = C_R \cdot R_{ins}$ at 20 °C,			
rel. humidity \leq 65%			
(minimum as-delivered			
values)			
DC test voltage	1.4 · V _R , 2 s		
Category voltage $V_{\rm C}$	T _{op} (°C)	DC voltage derating	AC voltage derating
(continuous operation with	T _{op} ≤85	$V_{\rm C} = V_{\rm R}$	$V_{C,RMS} = V_{RMS}$
V_{DC} or V_{AC} at f \leq 1 kHz)	85 <t<sub>op≤110</t<sub>	$V_{C} = V_{R} \cdot (165 - T_{op})/80$	$V_{C,RMS} = V_{RMS} \cdot (165 - T_{op})/80$
Operating voltage V_{op} for	T _{op} (°C)	DC voltage (max. hours)	AC voltage (max. hours)
short operating periods	T _{op} ≤100	$V_{op} = 1.1 \cdot V_{C} (1000 \text{ h})$	$V_{op} = 1.0 \cdot V_{C,RMS} (1000 \text{ h})$
$(V_{DC} \text{ or } V_{AC} \text{ at } f \le 1 \text{ kHz})$	$100 < T_{op} \le 125$	$V_{op} = 1.0 \cdot V_{C} (1000 \text{ h})$	$V_{op} = 1.0 \cdot V_{C,RMS} (1000 \text{ h})$
Biased humidity	1000 h / 40 °C	/ 93% relative humidity w	ith V _{R,DC}
Limit values after humidity	Capacitance cl	nange ∆C/C	≤ 5%
test	Dissipation fac	tor change Δ tan δ	≤ 0.002 (at 1 kHz)
	Insulation resis	stance R _{ins}	≥ 200 MΩ
Reliability:			
Failure rate λ	24 fit (≤ 24 · 10	⁹ /h) at 0.5 ⋅ V _R , 40 °C	
Service life t _{SL}	200000 h at 0.	5 · V _R , 85 °C	
	For conversion	to other operating condit	ions and temperatures, refer
	to chapter "Qu	ality, 2 Reliability".	
Failure criteria:			
Total failure	Short circuit or		
Failure due to variation	Capacitance change $ \Delta C/C $		> 10%
of parameters	Dissipation fac	tor tan δ	> 4 \cdot upper limit values
	Insulation resis	stance R _{ins}	< 150 M Ω (C _R \leq 0.33 μ F)
	Or time consta	nt τ	< 50 s ($C_{\rm R} \ge 0.33 \ \mu F$)





Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in $V/\mu s$.

" k_0 " represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V²/µs.

Note:

The values of dV/dt and k_0 provided below must not be exceeded in order to avoid damaging the capacitor. These parameters are given for isolated pulses in such a way that the heat generated by one pulse will be completely dissipated before applying the next pulse. For a train of pulses, please refer to the curves of permissible AC voltage-current versus frequency.

dV/dt values

Lead sp	acing	10 mm	15 mm	22.5 mm
V _R	V_{RMS}			
V DC	V AC	dV/dt in V/µs		
450	160	140	120	100
520	200	200	160	110
630	200	250	180	130

k₀ values

Lead sp	acing	10 mm	15 mm	22.5 mm
V _R	V_{RMS}			
V DC	V AC	k₀ in V²/μs		
450	160	126000	108000	90000
520	200	208000	166000	114000
630	200	315000	226000	163000

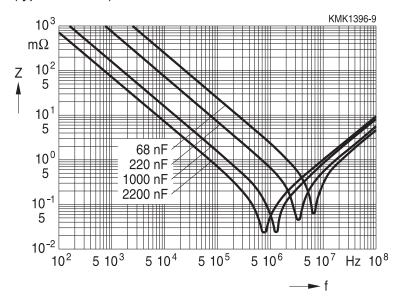




B32671P ... B32673P Power Factor Correction

Impedance Z versus frequency f

(typical values)





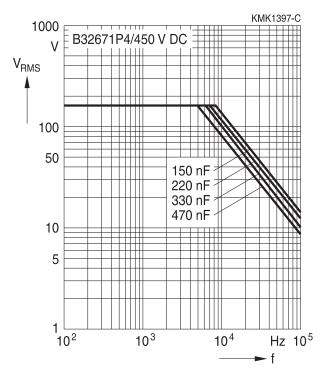


Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms T_A \leq 100 °C)

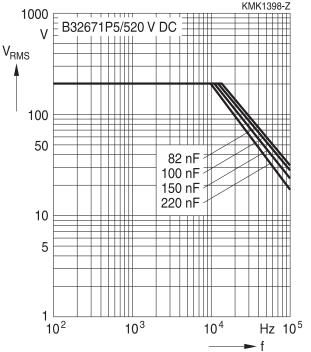
For $T_A > 100 \,^{\circ}$ C, please use derating factor F_T .

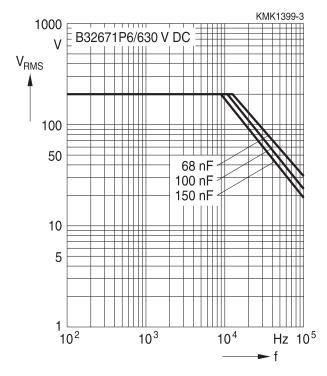
Lead spacing 10 mm

450 V DC/160 V AC



520 V DC/200 V AC







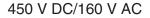
B32672P Power Factor Correction

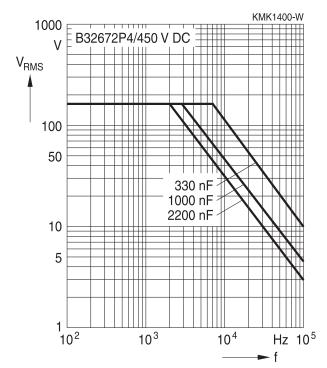
МКР → 15 ◄

Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms T_A \leq 100 °C)

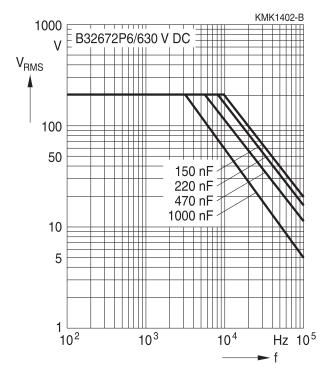
For $T_A > 100 \,^{\circ}$ C, please use derating factor F_T .

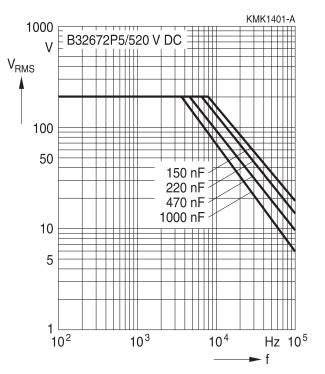
Lead spacing 15 mm





630 V DC/200 V AC







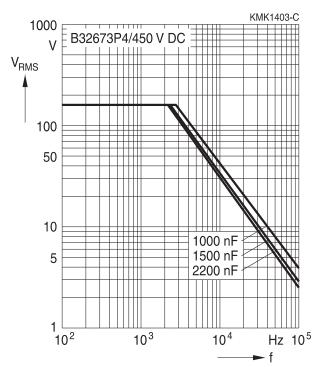


Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms T_A \leq 100 °C)

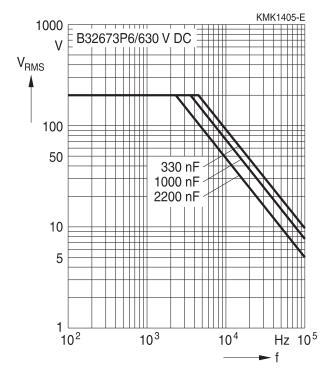
For $T_A > 100 \,^{\circ}$ C, please use derating factor F_T .

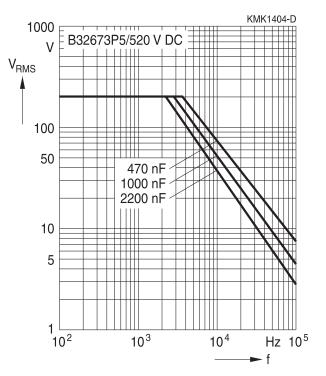
Lead spacing 22.5 mm

450 V DC/160 V AC



630 V DC/200 V AC









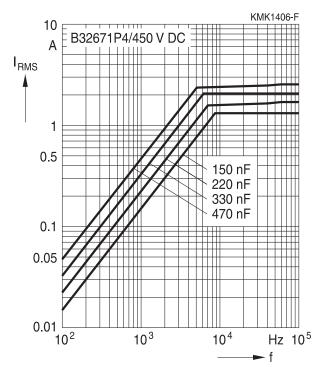


Permissible AC current I_{RMS} versus frequency f (for sinusoidal waveforms T_A \leq 100 °C)

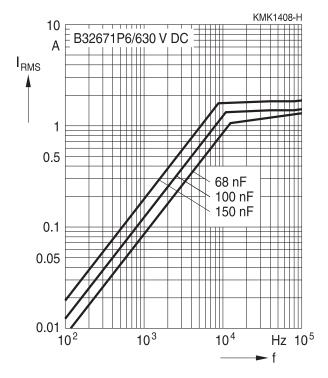
For $T_A > 100 \degree$ C, please use derating factor F_T .

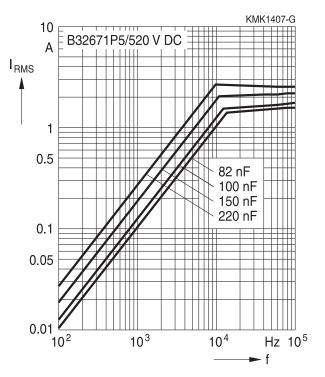
Lead spacing 10 mm

450 V DC/160 V AC



630 V DC/200 V AC







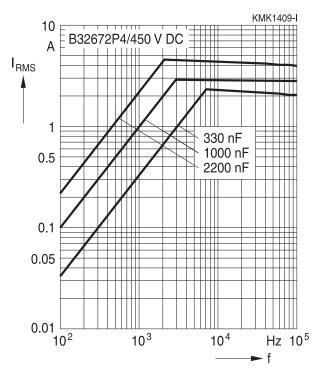


Permissible AC current I_{RMS} versus frequency f (for sinusoidal waveforms T_{A} ${\leq}100$ $^{\circ}\text{C}$)

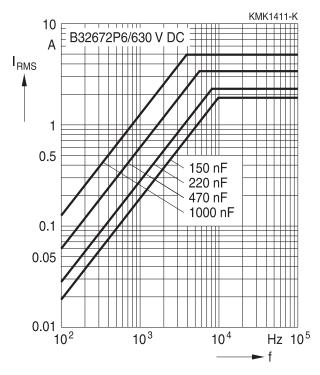
For $T_A > 100 \degree$ C, please use derating factor F_T .

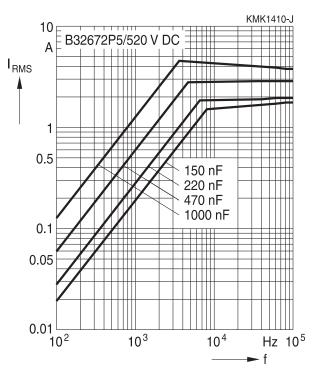
Lead spacing 15 mm

450 V DC/160 V AC



630 V DC/200 V AC







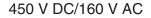
B32673P Power Factor Correction

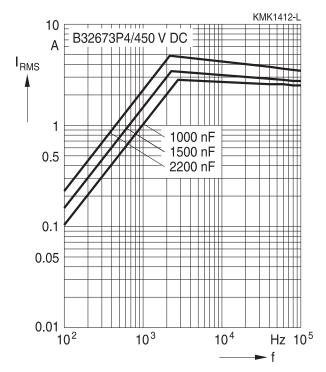


Permissible AC current I_{RMS} versus frequency f (for sinusoidal waveforms T_A \leq 100 °C)

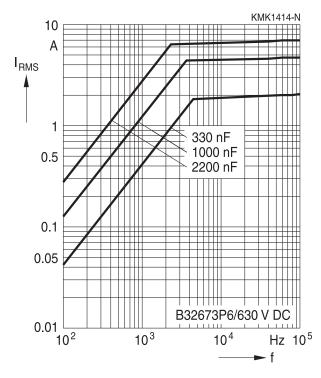
For $T_A > 100 \degree$ C, please use derating factor F_T .

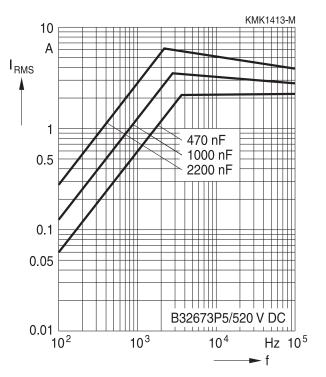
Lead spacing 22.5 mm





630 V DC/200 V AC







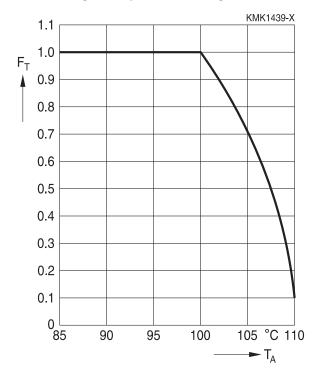


Maximum AC voltage (V_{RMS}), current (I_{RMS}) versus frequency and temperature for T_A >100 $^{\circ}$ C

The graphs described in the previous section for the permissible AC voltage (V_{RMS}) or current (I_{RMS}) versus frequency are given for a maximum ambient temperature $T_A \leq 100 \ ^{\circ}C$. In case of higher ambient temperatures (T_A), the self-heating (Δ T) of the component must be reduced to avoid that temperature of the component (T_{op}= T_A + Δ T) reaches values above maximum operating temperature.The factor F_T shall be applied in the following way:

 $I_{RMS} (T_A) = I_{RMS,T_A \le 100 °C} \cdot F_T(T_A)$ $V_{RMS} (T_A) = V_{RMS,T_A \le 100 °C} \cdot F_T(T_A)$

And F_{T} is given by the following curve:





Power Factor Correction



Testing and Standards

Test	Reference	Conditions of test		Performance requirements
Electrical parameters	IEC 60384-16:2005			Within specified limits
Robustness of termina- tions	IEC 60068-2-21:2006		t Ua1) Tensile force 0 N	Capacitance and tan δ within specified limits
Resistance to soldering heat	IEC 60068-2-20:2008, test Tb, method 1A	Solder bath temperat immersion for 10 sec		$\begin{array}{l} \Delta C/C_0 \leq 2\% \\ \Delta \tan \delta \leq 0.001 \end{array}$
Rapid change of temperature	IEC 60384-16:2005	T_A = lower category t T_B = upper category t Five cycles, duration	temperature	$\begin{split} \Delta C/C_0 &\leq 2\% \\ \Delta \tan \delta &\leq 0.002 \\ R_{ins} &\geq 50\% \text{ of initial limit} \end{split}$
Vibration	IEC 60384-16:2005	Test F _c : vibration sinusoidal Displacement: 0.75 mm Accleration: 98 m/s ² Frequency: 10 Hz 500 Hz Test duration: 3 orthogonal axes, 2 hours each axe		No visible damage
Bump	IEC 60384-16:2005	Test Eb: Total 4000 390 m/s ² mounted or Duration: 6 ms		No visible damage $ \Delta C/C_0 \le 2\%$ $ \Delta \tan \delta \le 0.001$ $R_{ins} \ge 50\%$ of initial limit
Climatic sequence	IEC 60384-16:2005	Dry heat Tb / 16 h Damp heat cyclic, 1^{st} cycle +55 °C / 24 h / 95% 100% RH Cold Ta / 2 h Damp heat cyclic, 5 cycles +55 °C / 24 h / 95% 100% RH		No visible damage $ \Delta C/C_0 \le 2\%$ $ \Delta \tan \delta \le 0.001$ $R_{ins} \ge 50\%$ of initial limit
Damp heat, steady state	IEC 60384-16:2005	Test Ca 40 °C / 93% RH / 56 days		$\begin{array}{l} \mbox{No visible damage} \\ \Delta C/C_0 \leq 3\% \\ \Delta \tan \delta \leq 0.003 \\ R_{ins} \geq 50\% \mbox{ of initial limit} \end{array}$
Advanced biased humidity		60 °C / 95% RH / 100 with V _{R,DC}	00 hours	$\begin{split} & \text{No visible damage} \\ & \Delta C/C_0 \leq 10\% \\ & \Delta \tan \delta \leq 0.004 \\ & \text{R}_{\text{ins}} \geq 50\% \text{ of initial limit} \end{split}$





Power Factor Correction

Test	Reference	Conditions of test	Performance requirements
Endurance A		85 °C / 1.1 V _R / 1000 hours	No visible damage
			$ \Delta C/C_0 \le 5\%$
			$ \Delta \tan \delta \le 0.004$
			$R_{ins} \ge 50\%$ of initial limit
Endurance B		110 °C / 1.1 V _c / 1000 hours	No visible damage
			$ \Delta C/C_0 \le 10\%$
			$ \Delta \tan \delta \le 0.004$
			$R_{ins} \ge 50\%$ of initial limit
Endurance C		125 °C / 1.1 V _c / 1000 hours	No visible damage
			$ \Delta C/C_0 \le 10\%$
			$ \Delta \tan \delta \le 0.004$
			$R_{ins} \ge 50\%$ of initial limit
Endurance D		85 °C/ V _R + 4 A _{RMS,1000 KHz} / 1000 hours	No visible damage
			$ \Delta C/C_0 \le 10\%$
			$ \Delta \tan \delta \le 0.004$
			$R_{ins} \ge 50\%$ of initial limit

Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 + 0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder





Power Factor Correction

1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1. Conditions:

Series	S	Solder bath temperature	Soldering time	
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing >10 mm)	260 ±5 °C	10 ±1 s	
MFP				
MKP	(lead spacing >7.5 mm)			
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5±1 s	
MKP	(lead spacing ≤7.5 mm)		<4 s	
MKT	uncoated (lead spacing ≤10 mm) insulated (B32559)		recommended soldering profile for MKT uncoated (lead spacing \leq 10 mm) and insulated (B32559)	
300	KMK1242-V			
°C				
т				
250				
200				
150				
100				
50				
0	0 50 100 150 200 s 25	-		
	0 50 100 150 200 s 20 → t	50		
Imme	rsion depth	$2.0 \pm 0/-0.5$ mm from car	pacitor body or seating plane	
Shield	•			
Onicit	4	Heat-absorbing board, (1.5 ± 0.5) mm thick, between capacitor body and liquid solder		
Evalu	ation criteria:			
Visua	l inspection	No visible damage		
		2% for MKT/MKP/MFP		
$\Delta C/C_{0}$	0	5% for EMI suppression capacitors		
tan δ		As specified in sectional specification		

Please read *Cautions and warnings* and *Important notes* at the end of this document.

Page 19 of 28





Power Factor Correction

1.3 General notes on soldering

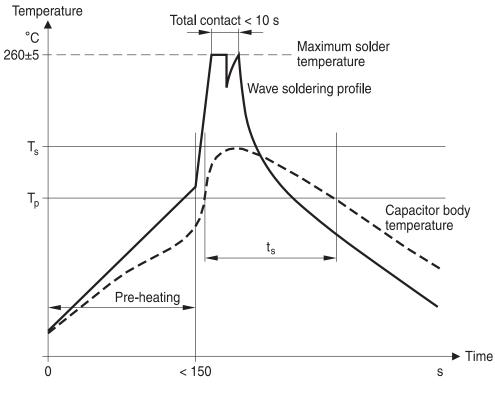
Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
- diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

Recommendations

As a reference, the recommended wave soldering profile for our film capacitors is as follows:

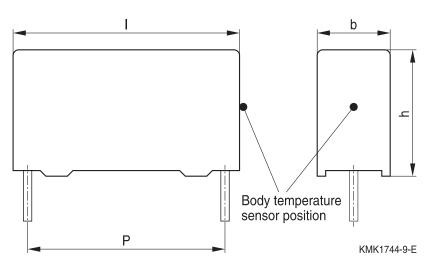


T_s: Capacitor body maximum temperature at wave soldering T_p: Capacitor body maximum temperature at pre-heating кмк1745-А-Е









Body temperature should follow the description below:

- MKP capacitor During pre-heating: T_p ≤110 °C During soldering: T_s ≤120 °C, t_s ≤45 s
- MKT capacitor During pre-heating: T_p ≤125 °C During soldering: T_s ≤160 °C, t_s ≤45 s

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T_s) must be \leq 120 °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be <360 °C and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings \leq 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to our Film Capacitors Data Book in case more details are needed.



MKP

B32671P ... B32673P

Power Factor Correction

Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of TDK Electronics.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Торіс	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6:2007. TDK Electronics offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"



MKP

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y information	Reference chapter
	"Mounting guidelines"
ot exceed the specified time or temperature limits g soldering.	1 "Soldering"
only suitable solvents for cleaning capacitors.	2 "Cleaning"
embedding finished circuit assemblies in plastic	3 "Embedding of

		"Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits	1 "Soldering"
	during soldering.	
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of	When embedding finished circuit assemblies in plastic	3 "Embedding of
capacitors in	resins, chemical and thermal influences must be taken	capacitors in finished
finished	into account.	assemblies"
assemblies	Caution: Consult us first, if you also wish to embed	
	other uncoated component types!	

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The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.

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www.tdk-electronics.tdk.com/orderingcodes.

Safety

Topic

Correlation of data sheet values and modelling tool outputs

Data sheet values and results of design tools may deviate as they have not been derived in the same context.

While data sheets show individual parameter statements without considering a possible dependency to other parameters. Tools model a complete given scenario as input and processed inside the tool.

Furthermore as we constantly strive to improve our models, the results of tools can change over time and be a non-binding indication only.



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B32671P ... B32673P

Power Factor Correction

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_{c}	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
А	Capacitor surface area	Kondensatoroberfläche
βc	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C _R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V / \Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f ₂	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f _r	Resonant frequency	Resonanzfrequenz
F _D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F _τ	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I _C	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)



MKP

Power Factor Correction

Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
i _z	Capacitance drift	Inkonstanz der Kapazität
k ₀	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λο	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
R _i	Internal resistance	Innenwiderstand
R _{ins}	Insulation resistance	Isolationswiderstand
R _P	Parallel resistance	Parallelwiderstand
R _s	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissingtion factor	Vorlustfaktor

1001		
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P _{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
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R _{ins}	Insulation resistance	Isolationswiderstand
R _P	Parallel resistance	Parallelwiderstand
Rs	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
tan δ_{D}	Dielectric component of dissipation	Dielektrischer Anteil des Verlustfaktors
	factor	
tan δ_P	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan δ_s	Series component of dissipation factor	Serienanteil des Verlustfaktors
T _A	Temperature of the air surrounding the	Temperatur der Luft, die das Bauteil
	component	umgibt
T _{max}	Upper category temperature	Obere Kategorietemperatur
T_{min}	Lower category temperature	Untere Kategorietemperatur
t _{OL}	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
	and voltage	-spannung
T _{op}	Operating temperature, $T_A + \Delta T$	Beriebstemperatur, $T_A + \Delta T$
T _R	Rated temperature	Nenntemperatur
T_{ref}	Reference temperature	Referenztemperatur
t _{SL}	Reference service life	Referenz-Lebensdauer



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B32671P ... B32673P

Power Factor Correction

Symbol	English	German
V _{AC}	AC voltage	Wechselspannung
V _c	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
V _i	Input voltage	Eingangsspannung
Vo	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V _p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V _R	Rated voltage	Nennspannung
ν _R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



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